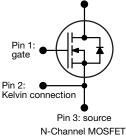
**Vishay Siliconix** 



## **E Series Power MOSFET**





Pin 4: drain

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.130			
Q <sub>g</sub> max. (nC)	116				
Q <sub>gs</sub> (nC)	19				
Q <sub>gd</sub> (nC)	33				
Configuration	Single				

#### **FEATURES**

- · Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH24N65E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-source voltage	V <sub>DS</sub>	650	V			
Gate-source voltage	V <sub>GS</sub>	± 30	v			
Continuous drain current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	Ι <sub>D</sub>	23			
	$V_{GS}$ at 10 V $T_C = 100 \text{ °C}$		15	А		
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	58				
Linear derating factor		1.61	W/°C			
Single pulse avalanche energy <sup>b</sup>	E <sub>AS</sub>	353	mJ			
Maximum power dissipation	PD	202	W			
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	T <sub>J</sub> = 125 °C	dV/dt	70	- V/ns		
Reverse diode dV/dt <sup>c</sup>		uv/ut	16	v/ns		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5 A

c.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

1



RoHS COMPLIANT HALOGEN FREE GREEN (5-2008)



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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	38		50					
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.48 0.62			°C/W				
		•							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	se noted)							
PARAMETER	SYMBOL	1	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static					•				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μA	650	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$		e to 25 °C,		-	0.75	-	V/°C	
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		$V_{GS}$ , $I_D = 2$		2.0	-	4.0	V	
		-	$V_{GS} = \pm 20$		-	-	± 100	nA	
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		-	-	± 1	μA	
		V <sub>DS</sub> =	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V	', T <sub>J</sub> = 125 °C	-	-	25	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		<sub>0</sub> = 12 A	-	0.130	0.150	Ω	
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	= 12 A	-	8.2	-	S	
Dynamic						•			
Input Capacitance	C <sub>iss</sub>		$V_{ee} = 0.V$		-	2814	-		
Output Capacitance	C <sub>oss</sub>	,	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	121	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	1		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 520 V, $V_{GS}$ = 0 V		-	88	-	pF		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	365	-			
Total Gate Charge	Qg				-	77	116		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 12 /	A, V <sub>DS</sub> = 520 V	-	19	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	33	-		
Turn-On Delay Time	t <sub>d(on)</sub>				-	29	58		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	520 V, I <sub>D</sub> =	= 12 A,	-	59	71		
Turn-Off Delay Time	t <sub>d(off)</sub>		$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	78	117	ns	
Fall Time	t <sub>f</sub>				-	46	92	1	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.27	0.55	1.10	Ω		
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	А		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	58			
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 12 A	, V <sub>GS</sub> = 0 V	-	0.9	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>			10.4	-	436	872	ns	
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 12 \text{ A}$ , dl/dt = 100 A/µs, $V_B = 25 \text{ V}$		-	7.4	14.8	μC		
Reverse Recovery Current	I <sub>RRM</sub>			n <b></b>	-	29	-	А	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ 

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

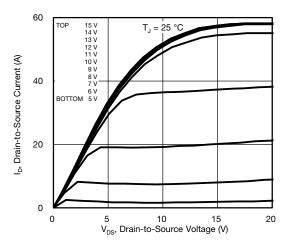


Fig. 1 - Typical Output Characteristics

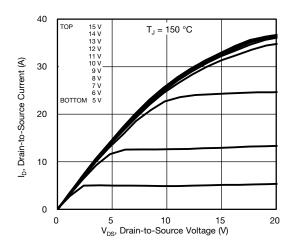
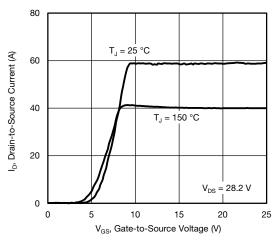


Fig. 2 - Typical Output Characteristics





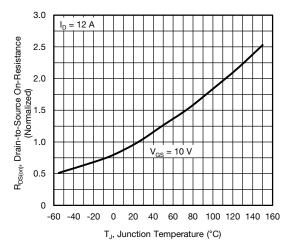


Fig. 4 - Normalized On-Resistance vs. Temperature

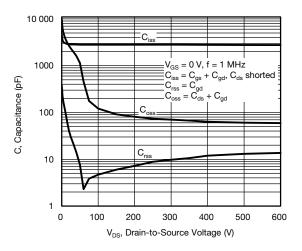


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

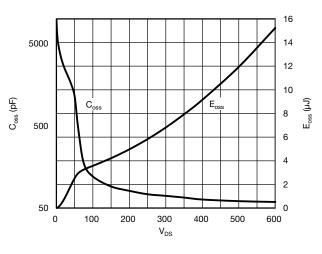


Fig. 6 -  $C_{\text{OSS}}$  and  $E_{\text{OSS}}$  vs.  $V_{\text{DS}}$ 

S23-0652-Rev. B, 21-Aug-2023

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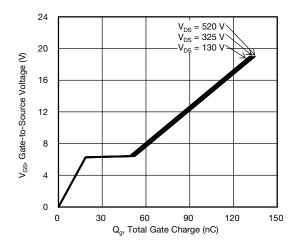


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

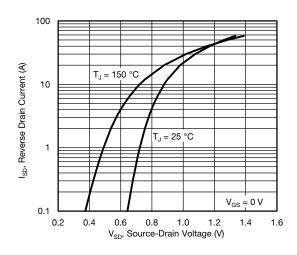


Fig. 8 - Typical Source-Drain Diode Forward Voltage

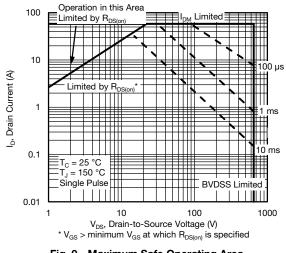


Fig. 9 - Maximum Safe Operating Area

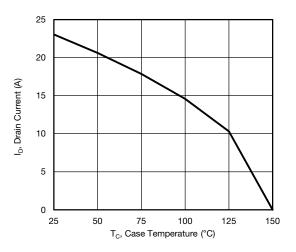


Fig. 10 - Maximum Drain Current vs. Case Temperature

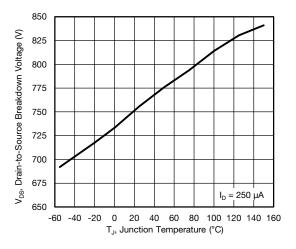
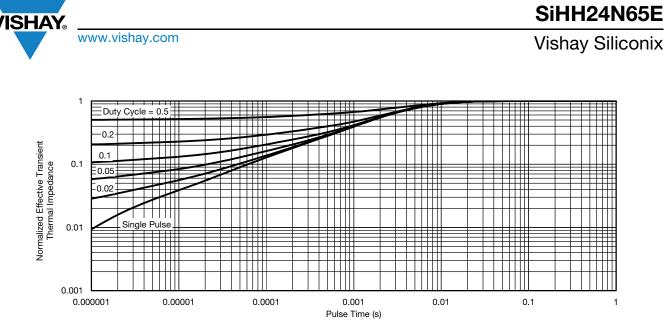


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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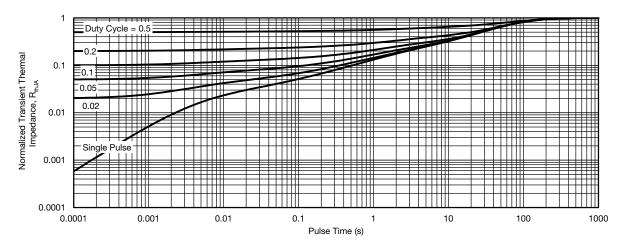


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

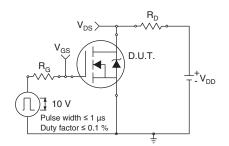


Fig. 14 - Switching Time Test Circuit

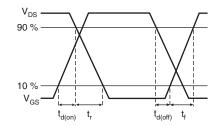


Fig. 15 - Switching Time Waveforms

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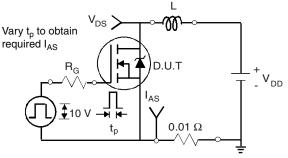


Fig. 16 - Unclamped Inductive Test Circuit

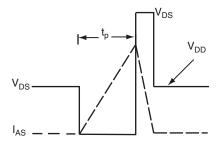


Fig. 17 - Unclamped Inductive Waveforms

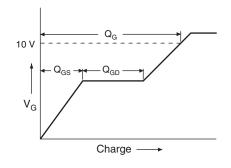


Fig. 18 - Basic Gate Charge Waveform

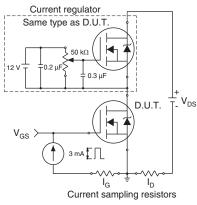
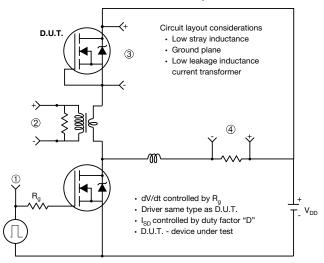


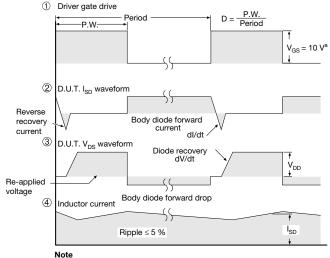
Fig. 19 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit





a.  $V_{GS} = 5 V$  for logic level devices

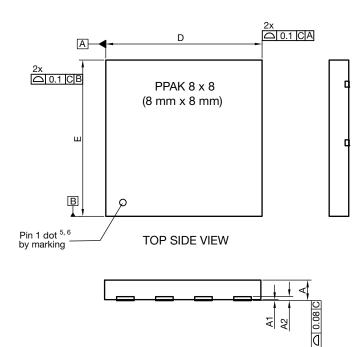
Fig. 20 - For N-Channel

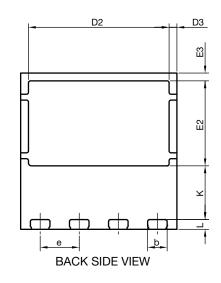
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC	0.40 BSC 0.016 BSC		0.016 BSC		
е		2.00 BSC		0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC		0.016 BSC			
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>(3)</sup>	8			8			

#### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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Revision: 01-Jan-2024